74ABT00

Quad 2-input NAND gate

Rev. 3 — 11 August 2016

Product data sheet

1. General description

The 74ABT00 high-performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

The 74ABT00 is a quad 2-input NAND gate.

2. Features and benefits

- Latch-up protection exceeds 500 mA per JESD78B class II level A
- ESD protection:
 - ♦ HBM JESD22-A114F exceeds 2000 V
 - ♦ MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from –40 °C to +85 °C

3. Ordering information

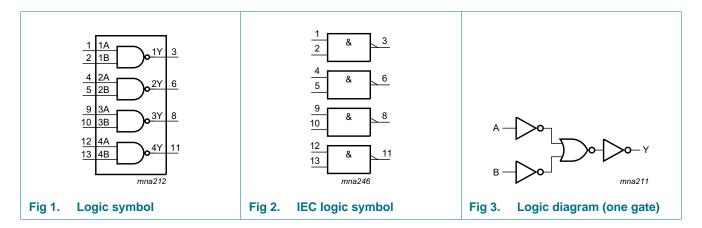
Table 1. Ordering information

	Package										
	Temperature range	Name	Description	Version							
74ABT00D	–40 °C to +85 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1							
74ABT00DB	−40 °C to +85 °C	SSOP14	plastic shrink small outline package; 14 leads; body width 5.3 mm	SOT337-1							
74ABT00PW	−40 °C to +85 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1							



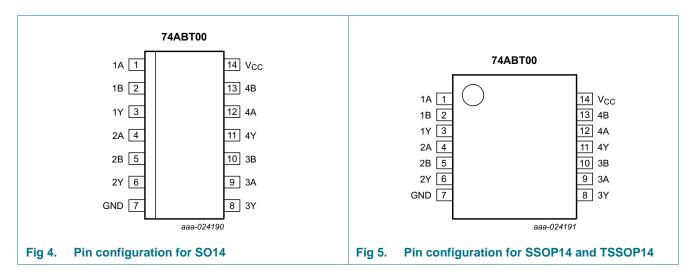
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4. Functional diagram



5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1A to 4A	1, 4, 9, 12	data input
1B to 4B	2, 5, 10, 13	data input
1Y to 4Y	3, 6, 8, 11	data output
GND	7	ground (0 V)
Vcc	14	supply voltage

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6. Functional description

Table 3. Function table[1]

Input		Output
nA	nB	nY
L	X	Н
X	L	Н
Н	Н	L

^[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7.0	V
VI	input voltage	[1]	-1.2	+7.0	V
Vo	output voltage	output HIGH or LOW	-0.5	+5.5	V
I _{IK}	input clamping current	V _I < 0 V	-18	-	mA
I _{OK}	output clamping current	V _O < 0 V	-50	-	mA
Io	output current	output in LOW-state	-	40	mA
Tj	junction temperature	[2]	-	150	°C
T _{stg}	storage temperature		-65	+150	°C

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

8. Recommended operating conditions

Table 5. Operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		4.5	-	5.5	V
VI	input voltage		0	-	V _{CC}	V
V_{IH}	HIGH-level input voltage		2.0	-	-	V
V_{IL}	LOW-level input voltage		-	-	0.8	V
I _{OH}	HIGH-level output current		-15	-	-	mA
I _{OL}	LOW-level output current		-	-	20	mA
Δt/ΔV	input transition rise and fall rate		0	-	5	ns/V
T _{amb}	ambient temperature	in free air	-40	-	+85	°C

^[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150 °C.

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9. Static characteristics

Table 6. Static characteristics

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	Unit
			Min	Тур	Max	Min	Max	
V_{IK}	input clamping voltage	$V_{CC} = 4.5 \text{ V}; I_{IK} = -18 \text{ mA}$	-1.2	-0.9	-	-1.2	-	V
V _{OH}	HIGH-level output voltage	V_{CC} = 4.5 V; I_{OH} = -15 mA; V_I = V_{IL} or V_{IH}	2.5	2.9	-	2.5	-	V
V _{OL}	LOW-level output voltage	V_{CC} = 4.5 V; I_{OL} = 20 mA; V_I = V_{IL} or V_{IH}	-	0.35	0.5	-	0.5	V
I _I	input leakage current	$V_{CC} = 5.5 \text{ V}; V_I = \text{GND or } 5.5 \text{ V}$	-	±0.01	±1.0	-	±1.0	μΑ
I _{OFF}	power-off leakage current	$V_{CC} = 0 \text{ V}; \text{ V}_{I} \text{ or } \text{V}_{O} \le 4.5 \text{ V}$	-	±5.0	±100	-	±100	μΑ
I _{CEX}	output high leakage current	HIGH-state; $V_O = 5.5 \text{ V}$; $V_{CC} = 5.5 \text{ V}$; $V_I = \text{GND or } V_{CC}$	-	5.0	50	-	50	μΑ
Io	output current	$V_{CC} = 5.5 \text{ V}; V_O = 2.5 \text{ V}$ [1]	-50	-75	-180	-50	-180	mA
I _{CC}	supply current	$V_{CC} = 5.5 \text{ V}; V_I = \text{GND or } V_{CC}$	-	2	50	-	50	μΑ
Δl _{CC}	additional supply current	per input pin; V _{CC} = 5.5 V; one input at 3.4 V; other inputs at V _{CC} or GND	-	0.25	500	-	500	μΑ
Cı	input capacitance	V _I = 0 V or V _{CC}	-	3	-	-	-	pF

^[1] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

10. Dynamic characteristics

Table 7. Dynamic characteristics GND = 0 V; for test circuit, see <u>Figure 7</u>.

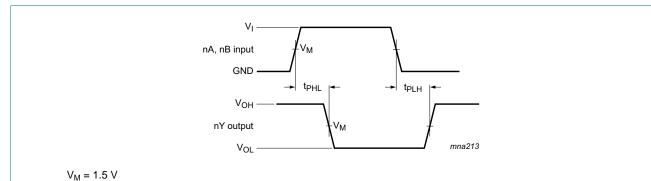
Symbol	Parameter	Conditions	25 °C	; V _{CC} =	5.0 V	-40 °C to V _{CC} = 5.0	Unit	
			Min	Тур	Max	Min	Max	
t _{PLH}	LOW to HIGH propagation delay	nA, nB to nY; see Figure 6	1.0	2.5	3.6	1.0	4.1	ns
t _{PHL}	HIGH to LOW propagation delay	nA, nB to nY; see Figure 6	1.0	2.0	2.8	1.0	3.4	ns
t _{sk(o)}	output skew time	[1]	-	0.4	0.5	-	0.5	ns

^[1] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

^[2] This is the increase in supply current for each input at 3.4 V.

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11. Waveforms



V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 6. Propagation delay input (nA, nB) to output (nY) and output skew time

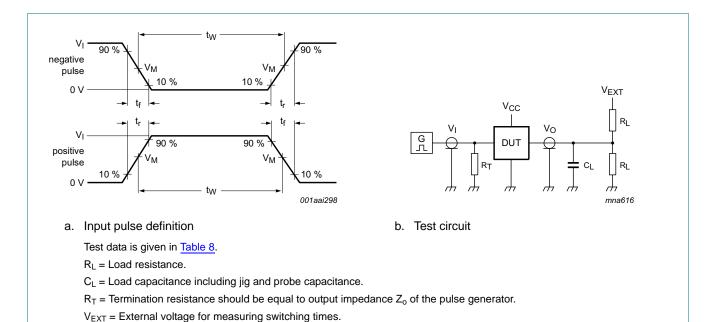


Fig 7. Test circuit for measuring switching times

Table 8. Test data

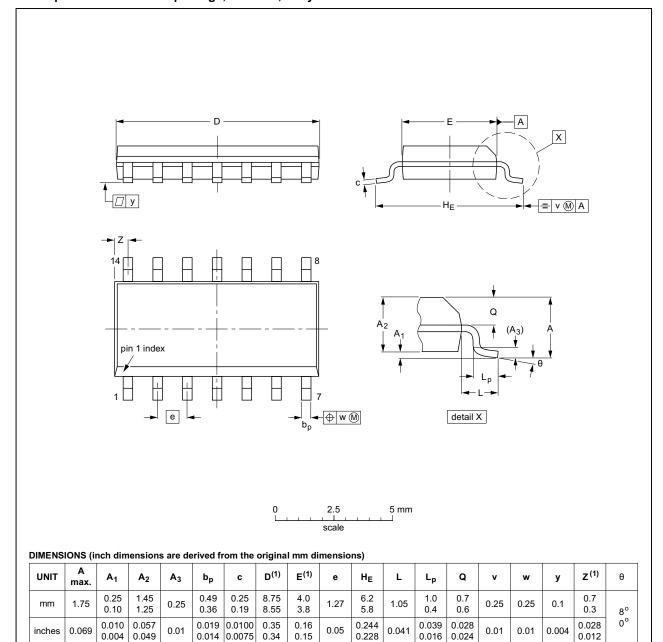
Input			Load	V _{EXT}			
V_{I}	f _i	t _W	t _r , t _f	CL	R _L	t _{PHL} , t _{PLH}	
3.0 V	1 MHz	500 ns	≤ 2.5 ns	50 pF	500 Ω	open	

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12. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT108-1	076E06	MS-012			99-12-27 03-02-19

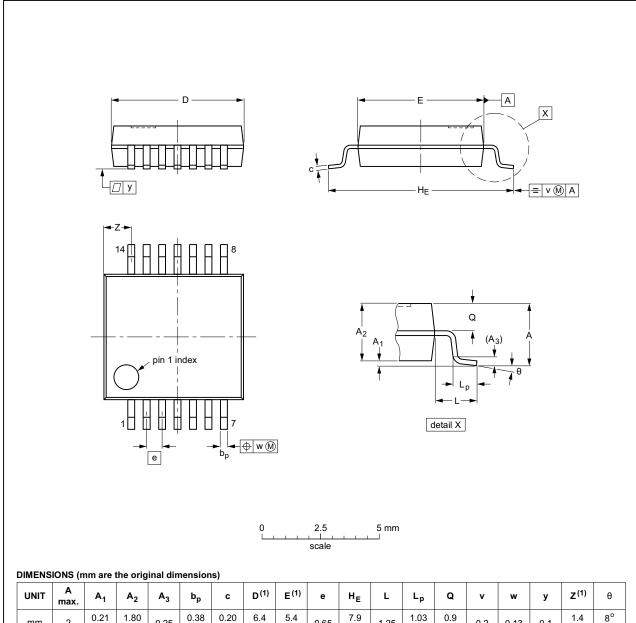
Fig 8. Package outline SOT108-1 (SO14)

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SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



UNIT	A max.	A ₁	A ₂	A ₃	b _p	C	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.4 0.9	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

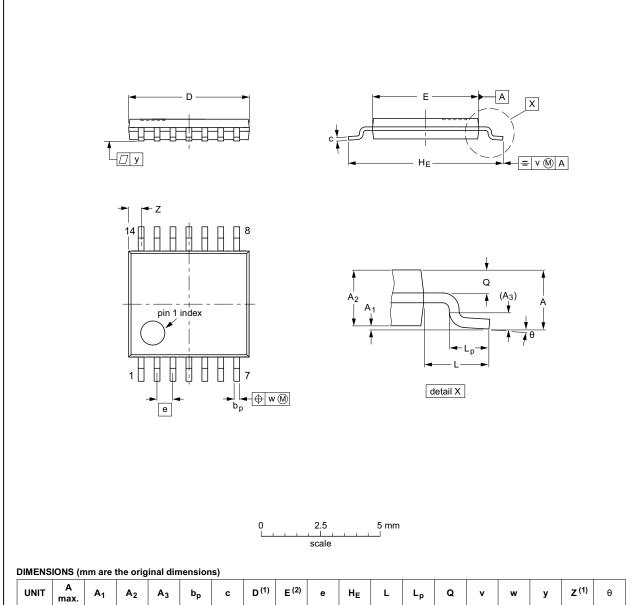
OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT337-1		MO-150			99-12-27 03-02-19

Package outline SOT337-1 (SSOP14) Fig 9.

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TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	٧	w	у	Z ⁽¹⁾	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

	OUTLINE VERSION	REFERENCES			EUROPEAN	ISSUE DATE		
		IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
	SOT402-1		MO-153				99-12-27 03-02-18	
	501402-1		MO-153				0	3-02-18

Fig 10. Package outline SOT402-1 (TSSOP14)

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13. Abbreviations

Table 9. Abbreviations

Acronym	Description	
BiCMOS	Bipolar Complementary Metal-Oxide Semiconductor	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
НВМ	Human Body Model	
MM	Machine Model	

14. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74ABT00 v.3	20160811	Product data sheet	-	74ABT00 v.2	
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 				
	 Legal texts have been adapted to the new company name where appropriate. 				
74ABT00 v.2	19950918	Product specification	-	-	

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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